RX14T Group

Handbook for RX14T

Introduction

This document compiles useful information for each stage of device selection, development, and Mass production. You can also select what you need for your application from our rich selection of application notes that describe how to use a peripheral function, example applications, how to create a program, and more.

Please utilize these information, materials and application notes as a handbook when developing.

Target Device

RX14T Group

Contents

1. The table of information and materials needed for Device Selection, Development and Mass production

1.1 Step1: Device Selection

This section summarizes the information that is useful for the preliminary survey phase (Step1-1) and for the evaluation phase of device performance and features (Step1-2) when selecting the device.

1.1.1 Step1-1: Preliminary survey phase

#	Item	Content	Link
1	Hardware information	Datasheet	Doc
2		RX Family Brochure	Doc
3	Products & Solutions	Video & blog	Web site
4		Product deatures, Application block diagram(Winning combination)	Web site
5	Product longevity program (PLP)	Overview of product longevity program (PLP)	Web site
6		Product selection (product selector) Note: Refer to Longevity column in the chart.	Web site
7	Product Specification Comparison	RX Family Product Selector	Web site
8		Motor Solution Brochure	Doc
9		Differences of specification among RX products	Doc
10		[SH/H8/H8S/H8SX/M16C/V850] → RX microcontroller migration guide	Doc
11		Design guide for migration between RX family differences in package external form	Doc

1.1.2 Step1-2: Evaluation phase of device performance and features

#	Item	Content	Link
User's Manual / Documentation			
1	Hardware information	User's manual: Hardware	Doc
2		RX family hardware manual guidance - electrical characteristics (how to read user's manual: hardware)	Doc
3		RX family hardware manual guidance - peripheral functions (how to read user's manual: hardware)	Doc
4		Technical update (errata information)	Web site
5		Product change notice (PCN)	Web site
6		Part number guide for RX family product (the meaning of character in part number)	Doc
7		Semiconductor reliability handbook	Doc
8		RELIABILITY REPORT	Doc
9		RoHS Note: Please refere to "RoHS" colmun on the respective part number of the product options.	Web site
10	Software information	Instruction set for RXv2 core architecture (user's manual)	Doc
Evaluation board			
11	Evaluation board (for general purpose)	Fast Prototyping Board(low-cost model)	Web site
12	Solution board	Renesas flexible motor control kit (CPU board + inverter board + communication board)	Web site
13		CPU board	Web site
14		MCI-LV-1 Renesas flexible motor control inverter board(Low voltage 48V/10A)	Web site
15		MCI-HV-1 Renesas flexible motor control inverter board(Low voltage 100V/200V)	Web site
16		MCI-HV-2-1PH Renesas flexible motor control inverter board(200-240VAC 1PH input)	Web site
17		MCI-HV-2-3PH Renesas flexible motor control inverter board(200V/240VAC 3PH input)	Web site
18		MC-COM Renesas flexible motor control communication board	Web site
Evaluation environment (set up method)			
19	Setup method	Getting started with the RX family development environment	Web site
20	Software tool	Development tools for RX family	Web site
21		Software environment (OS, middleware, drivers)	Web site
22		RX smart configurator user's guide (tools for code generation)	Doc

#	Item	Content	Link
Solution			
23	Motor and Inverter Control	Motor and inverter control solutions	Web site
24		Renesas motor workbench	Web site
25	GUI	Graphical user interface (GUI) solutions	Web site
26	Functional safety	Functional safety solutions for Industrial automation	Web site
27		Functional safety solution for industrial automation	Doc
28		Introduction to Renesas functional safety for industrial appliance(video)	Web site
29		Functional safety solution for home appliances	Web site
30		Introduction to Renesas functional safety for home appliance (video)	Web site
Training			
31	Training information	Smart configurator tutorial - create a LED blinking program using RX family MCU	Web site
32		How to use tools and solutions (video clips)	Web site
33		CC-RX compiler tutorial - How to use trigonometric function unit (TFU) of RX	Web site
Partner			
34	Partner information	Partner products (system solutions provider)	Web site
35		Partner products (trusted technology partners that deliver commercial-grade building blocks)	Web site

1.2 Step2: Product Design Development

This section summarizes useful information for product design and development.

#	Item	Content	Link
1	Board Design	Hardware design guide	Doc
2		Design guide for main clock circuit and Sub-Clock circuit	Doc
3		Notes regarding high-temperature operation	Doc
4		CAD Model Note: When you click the link in the CAD model column in the "Product Options" table on the product page, the CAD model information for each part# is displayed.	Web site
5		board simulation model (IBIS) *	Web site
6		Resonator and matching circuit information	Doc
7		Package information (package outline information, mount manual, etc.)	Web site

* It requires My Renesas account to access the content.

1.3 Step3: Mass Production

#	Item	Content	Link
1	Writing a program	PG-FP6	Web site
2		Renesas flash programmer (GUI tool for PC)	Web site
3	Memory protection	How to manage the access control for flash memory	Doc

1.4 Supportive information

Get help from our technical staff and community.

#	Item	Content	Link
1	Support information	FAQ (frequently asked inquiries)	Website
2		RX forum (community)	Website
3		Ask technical/sales support(support tickets)	Website

2. Highlighted Application Notes

This part presents the main application notes for this product. In addition to this list, many more application notes and sample codes are available on the product website <www.renesas.com/RX14T> for your reference. (Note: To access the content of sample code, My Renesas account is required.)

#	Item	Content	Link
1	System design	Examples of transitioning to low power consumption modes Application note	Doc
2		Examples of transitioning to low power consumption modes Sample code	Sample
3	Motor and Inverter Control	Sensorless vector control of a permanent magnet synchronous motor Application note	Doc
4		Sensorless vector control of a permanent magnet synchronous motor Sample code	Sample
5		Vector control for permanent magnet synchronous motor with encoder Application note	Doc
6		Vector control for permanent magnet synchronous motor with encoder Sample code	Sample
7		Vector control for permanent magnet synchronous motor with encoder (algorithm)	Doc
8		Sensor less vector control for permanent magnet synchronous motor (algorithm)	Doc
9		PFC-Controlled and sensorless Vector-Controlled by ceiling FAN inverter board with RX13T Application note	Doc
10		PFC-Controlled and sensorless Vector-Controlled by ceiling FAN inverter board with RX13T Sample code	Sample
11		Vector control of Three-Phase induction motor used in driving a fan Application note	Doc
12		Vector control of Three-Phase induction motor used in driving a fan Sample code	Sample
13		Vector control of Three-Phase induction motor used in driving a pump Application note	Doc
14		Vector control of Three-Phase induction motor used in driving a pump Sample code	Sample
15		PMBus Master-Slave communication using I2C bus interface (RIIC/I3C) Application note	Doc
16		PMBus Master-Slave communication using I2C bus interface (RIIC/I3C) sample code	Sample
17	GUI	QE for display GUI display application development guide using serial connection LCD	Doc
18		GUI sample program using serial LCD and emWin library Application note	Doc
19		GUI sample program using serial LCD and emWin library Sample code	Sample

#	Item	Content	Link
20		Module for image rendering (emWin) Application note	Doc
21		Module for image rendering (emWin) Sample code	Sample

Revision History

Rev.	Date	Description	
		Page	Summary
1.00	Apr. 7,2026	-	First edition issued

This handbook incorporates information available as of its publication date. For the most up-to-date details, please refer to the product page on our official website: <www.renesas.com/RX14T>

General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Precaution against Electrostatic Discharge (ESD)
   A strong electrical field, when exposed to a CMOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it when it occurs. Environmental control must be adequate. When it is dry, a humidifier should be used. This is recommended to avoid using insulators that can easily build up static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors must be grounded. The operator must also be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions must be taken for printed circuit boards with mounted semiconductor devices.
2. Processing at power-on
   The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power reaches the level at which resetting is specified.
3. Input of signal during power-off state
   Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.
4. Handling of unused pins
   Handle unused pins in accordance with the directions given under handling of unused pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of the LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible.
5. Clock signals
   After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable.
6. Voltage application waveform at input pin
   Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between V_{IL} (Max.) and V_{IH} (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between V_{IL} (Max.) and V_{IH} (Min.).
7. Prohibition of access to reserved addresses
   Access to reserved addresses is prohibited. The reserved addresses are provided for possible future expansion of functions. Do not access these addresses as the correct operation of the LSI is not guaranteed.
8. Differences between products
   Before changing from one product to another, for example to a product with a different part number, confirm that the change will not lead to problems. The characteristics of a microprocessing unit or microcontroller unit products in the same group but having a different part number might differ in terms of internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

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